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Understanding Embedded - FPGAs (Field Programmable Gate Array)

Embedded - FPGAs, or Field Programmable Gate Arrays, are advanced integrated circuits that offer unparalleled flexibility and performance for digital systems. Unlike traditional fixed-function logic devices, FPGAs can be programmed and reprogrammed to execute a wide array of logical operations, enabling customized functionality tailored to specific applications. This reprogrammability allows developers to iterate designs quickly and implement complex functions without the need for custom hardware.

Applications of Embedded - FPGAs

The versatility of Embedded - FPGAs makes them indispensable in numerous fields. In telecommunications,

Details	
Product Status	Obsolete
Number of LABs/CLBs	10000
Number of Logic Elements/Cells	40000
Total RAM Bits	4075520
Number of I/O	604
Number of Gates	-
Voltage - Supply	0.95V ~ 1.26V
Mounting Type	Surface Mount
Operating Temperature	0°C ~ 85°C (TJ)
Package / Case	1152-BCBGA, FCBGA
Supplier Device Package	1152-CFCBGA (35x35)
Purchase URL	https://www.e-xfl.com/product-detail/lattice-semiconductor/lfsc3ga40e-7fc1152c

PFU Modes of Operation

Slices can be combined within a PFU to form larger functions. Table 2-4 tabulates these modes and documents the functionality possible at the PFU level.

Table 2-4. PFU Modes of Operation

Logic	Ripple	RAM	ROM
LUT 4x8 or MUX 2x1 x 8	2-bit Add x 4	SPR 16x2 x 4 DPR 16x2 x 2	ROM 16x1 x 8
LUT 5x4 or MUX 4x1 x 4	2-bit Sub x 4	SPR 16x4 x 2 DPR 16x4 x 1	ROM 16x2 x 4
LUT 6x2 or MUX 8x1 x 2	2-bit Counter x 4	SPR 16x8 x 1	ROM 16x4 x 2
LUT 7x1 or MUX 16x1 x 1	2-bit Comp x 4		ROM 16x8 x1

Routing

There are many resources provided in the LatticeSC devices to route signals individually or as busses with related control signals. The routing resources consist of switching circuitry, buffers and metal interconnect (routing) segments.

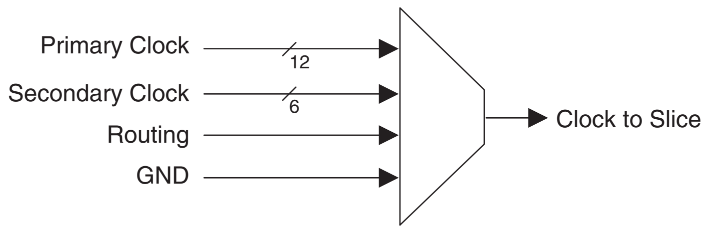
The inter-PFU connections are made with x1 (spans two PFU), x2 (spans three PFU) and x6 (spans seven PFU) resources. The x1 and x2 connections provide fast and efficient connections in horizontal, vertical and diagonal directions. All connections are buffered to ensure high-speed operation even with long high-fanout connections.

The ispLEVER design tool takes the output of the synthesis tool and places and routes the design. Generally, the place and route tool is completely automatic, although an interactive routing editor is available to optimize the design.

sysCLOCK Network

The LatticeSC devices have three distinct clock networks for use in distributing high-performance clocks within the device: primary clocks, secondary clocks and edge clocks. In addition to these dedicated clock networks, users are free to route clocks within the device using the general purpose routing. Figure 2-4 shows the clock resources available to each slice.

Figure 2-4. Slice Clock Selection



Note: GND is available to switch off the network.

Primary Clock Sources

LatticeSC devices have a wide variety of primary clock sources available. Primary clocks sources consists of the following:

- Primary clock input pins
- Edge clock input pins
- Two outputs per DLL

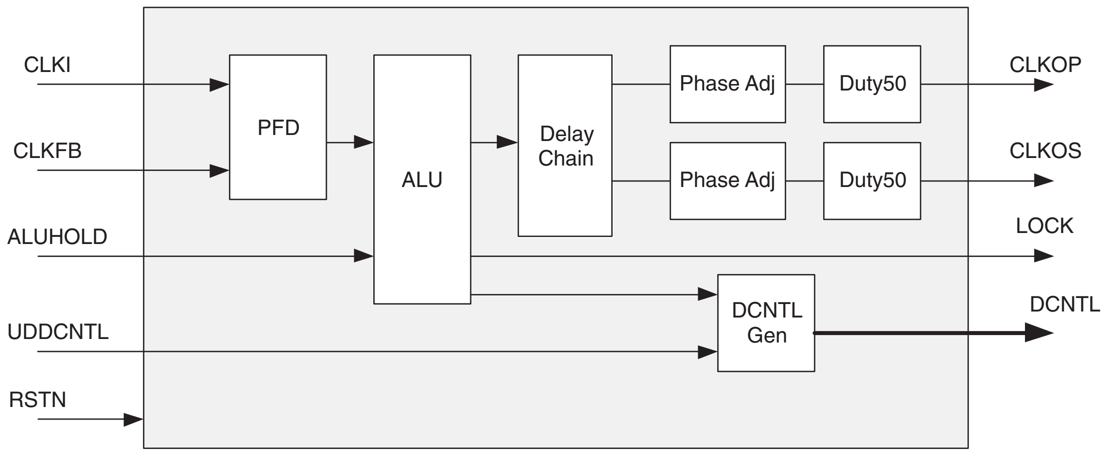
There is a Digital Control (DCNTL) bus available from the DLL block. This Digital Control bus is available to the delay lines in the PIC blocks in the adjacent banks. The UDDCNTL signal allows the user to latch the current value on the digital control bus.

Figure 2-12 shows the DLL block diagram of the DLL inputs and outputs. The output of the phase frequency detector controls an arithmetic logic unit (ALU) to add or subtract one delay tap. The digital output of this ALU is used to control the delay value of the delay chain and this digital code is transmitted via the DCNTL bus.

The sysCLOCK DLL can be configured at power-up, then, if desired, reconfigured dynamically through the Serial Memory Interface bus which interfaces with the on-chip Microprocessor Interface (MPI) bus. In addition, users can drive the SMI interface from routing if desired.

The user can configure the DLL for many common functions such as clock injection match and single delay cell. Lattice provides primitives in its design for time reference delay (DDR memory) and clock injection delay removal.

Figure 2-12. DLL Diagram



PLL/DLL Cascading

The LatticeSC devices have been designed to allow certain combinations of PLL and DLL cascading. The allowable combinations are as follows:

- PLL to PLL
- PLL to DLL
- DLL to DLL
- DLL to PLL

DLLs are used to shift the clock in relation to the data for source synchronous inputs. PLLs are used for frequency synthesis and clock generation for source synchronous interfaces. Cascading PLL and DLL blocks allows applications to utilize the unique benefits of both DLL and PLLs.

When cascading the DLL to the PLL, the DLL can be used to drive the PLL to create fine phase shifts of an input clock signal. Figure 2-13 shows a shift of all outputs for CLKOP and CLKOS out in time.

PURESPEED I/O Buffer Banks

LatticeSC devices have seven PURESPEED I/O buffer banks; each is capable of supporting multiple I/O standards. Each PURESPEED I/O bank has its own I/O supply voltage (V_{CCIO}), and two voltage references V_{REF1} and V_{REF2} resources allowing each bank to be completely independent from each other. Figure 2-26 shows the seven banks and their associated supplies. Table 2-7 lists the maximum number of I/Os per bank for the whole LatticeSC family.

In the LatticeSC devices, single-ended output buffers and ratioed input buffers (LVTTL, LVCMOS, PCI33 and PCIX33) are powered using V_{CCIO}. In addition to the bank V_{CCIO} supplies, the LatticeSC devices have a V_{CC} core logic power supply, and a V_{CCAUX} supply that power all differential and referenced buffers. VCCAUX also powers a predriver of single-ended output buffers to enhance buffer performance.

Each bank can support up to two separate VREF voltages, VREF1 and VREF2 that set the threshold for the referenced input buffers. In the LatticeSC devices any I/O pin in a bank can be configured to be a dedicated reference voltage supply pin. Each I/O is individually configurable based on the bank's supply and reference voltages.

Differential drivers have user selectable internal or external bias. External bias is brought in by the VREF1 pin in the bank. External bias for differential buffers is needed for applications that requires tighter than standard output common mode range.

Since a bank can have only one external bias circuit for differential drivers, LVDS and RSDS differential outputs can be mixed in a bank.

If a differential driver is configured in a bank, one pin in that bank becomes a DIFFR pin. This DIFFR pin must be connected to ground via an external 1K +/-1% ohm resistor. Note that differential drivers are not supported in banks 1, 4 and 5.

In addition, there are dedicated Terminating Supply (V_{TT}) pins to be used as terminating voltage for one of the two ways to perform parallel terminations. These V_{TT} pins are available in banks 2-7, these pins are not available in some packages. When VTT termination is not required, or used to provide the common mode termination voltage (VCMT), these pins can be left unconnected on the device. If the internal or external VCMT function for differential input termination is used, the VTT pins should be unconnected and allowed to float.

There are further restrictions on the use of V_{TT} pins, for additional details refer to technical information at the end of this data sheet.

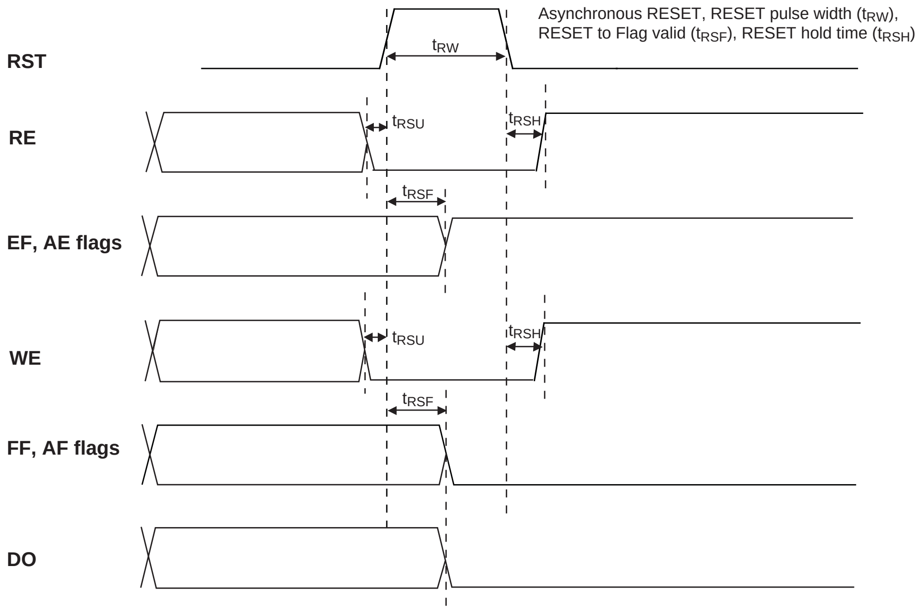
LatticeSC/M External Switching Characteristics[3]

Over Recommended Commercial Operating Conditions at VCC = 1.2V +/- 5%

Parameter	Description	-7		-6		-5		Units
		Min.	Max.	Min.	Max.	Min.	Max.	
General I/O Pin Parameters (using Primary Clock without PLL)[2]								
t_{CO}	Global Clock Input to Output - PIO Output Register	2.83	5.74	2.83	6.11	2.83	6.49	ns
t_{SU}	Global Clock Input Setup - PIO Input Register without fixed input delay	-0.66	—	-0.66	—	-0.66	—	ns
t_{H}	Global Clock Input Hold - PIO Input Register without fixed input delay	1.73	—	1.95	—	2.16	—	ns
t_{SU_IDLY}	Global Clock Input Setup - PIO Input Register with input delay	0.86	—	1.03	—	1.20	—	ns
t_{H_IDLY}	Global Clock Input Hold - PIO Input Register with input delay	-0.17	—	-0.17	—	-0.17	—	ns
f_{MAX_PFU}	Global Clock frequency of PFU register	—	700	—	700	—	700	MHz
f_{MAX_IO}	Global Clock frequency of I/O register	—	1000	—	1000	—	1000	MHz
t_{GC_SKEW}	Global Clock skew	—	89	—	103	—	116	ps
General I/O Pin Parameters (using Primary Clock with PLL)[1, 2]								
t_{CO}	Global Clock Input to Output - PIO Output Register	2.25	4.81	2.25	5.08	2.25	5.37	ns
t_{SU}	Global Clock Input Setup - PIO Input Register without fixed input delay	-0.07	—	-0.07	—	-0.07	—	ns
t_{H}	Global Clock Input Hold - PIO Input Register without fixed input delay	0.80	—	0.93	—	1.04	—	ns
General I/O Pin Parameters (using Edge Clock without PLL)[2]								
t_{CO}	Edge Clock Input to Output - PIO Output Register	2.38	4.77	2.38	5.04	2.38	5.33	ns
t_{SU}	Edge Clock Input Setup - PIO Input Register without fixed input delay	-0.08	—	-0.08	—	-0.08	—	ns
t_{H}	Edge Clock Input Hold - PIO Input Register	0.49	—	0.58	—	0.66	—	ns
t_{SU_IDLY}	Edge Clock Input Setup - PIO Input Register with input delay	0.81	—	0.97	—	1.12	—	ns
t_{H_IDLY}	Edge Clock Input Hold - PIO Input Register with input delay	-0.34	—	-0.34	—	-0.34	—	ns
t_{EC_SKEW}	Edge Clock skew	—	28	—	32	—	36	ps
General I/O Pin Parameters (using Latch FF without PLL)[2]								
t_{SU}	Latch FF, Input Setup - PIO Input Register without fixed input delay	-0.14	—	-0.14	—	-0.14	—	ns
t_{H}	Latch FF, Input Hold - PIO Input Register without fixed input delay	0.58	—	0.68	—	0.77	—	ns
t_{SU_IDLY}	Latch FF, Input Setup - PIO Input Register with input delay	0.70	—	0.68	—	0.77	—	ns
t_{H_IDLY}	Latch FF, Input Hold - PIO Input Register with input delay	-0.30	—	-0.30	—	-0.30	—	ns

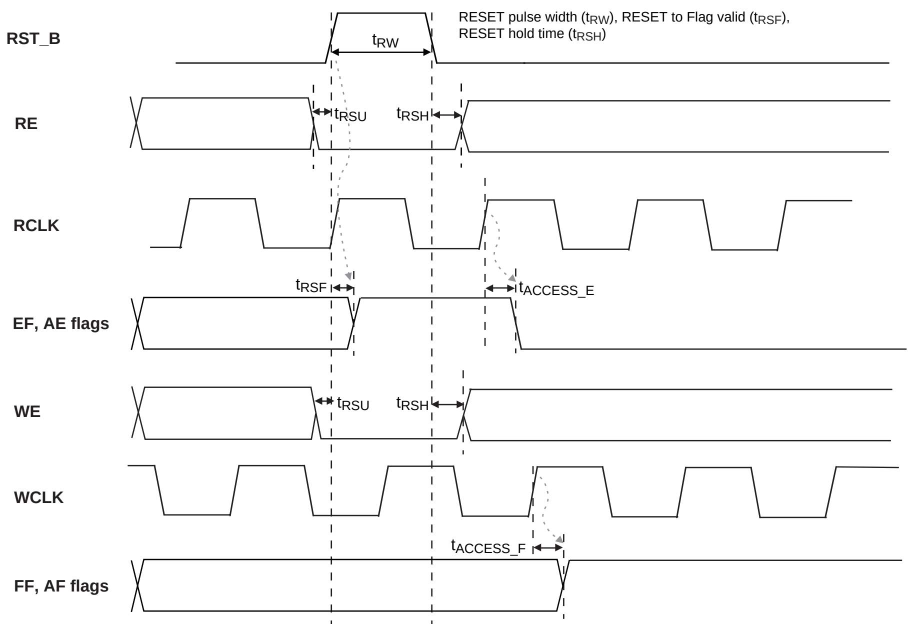
1. No PLL delay tuning (clock injection removal mode, system clock feedback).
2. Using LVCMOS25 12mA I/O. Timing adders for other supported I/O technologies are specified in the LatticeSC Family Timing Adders table.
3. Complete Timing Parameters for a user design are incorporated when running ispLEVER. This is a sampling of the key timing parameters. Timing specs are for non-AIL applications.

Figure 3-10. FIFO Reset Waveform



Note: RE and WE must be deactivated t_{RSU} before the Positive FIFO reset edge and enabled t_{RSH} after the FIFO reset negative edge.

Figure 3-11. Read Pointer Reset Waveform



Note: RE and WE must be deactivated t_{RSU} before the Positive FIFO reset edge and enabled t_{RSH} after the FIFO reset negative edge.

Figure 3-12. Waveforms First Read after Full Flag

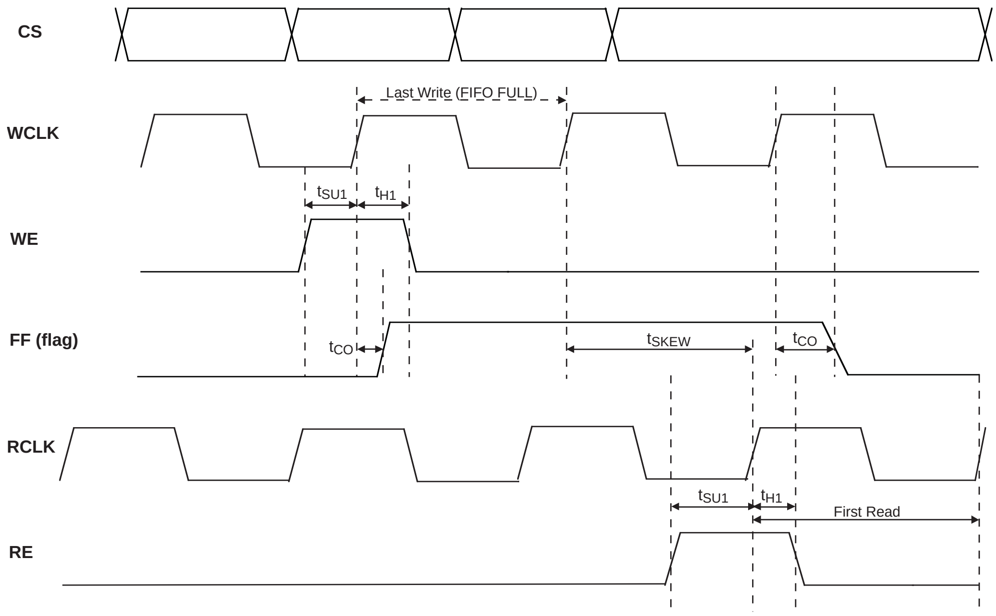
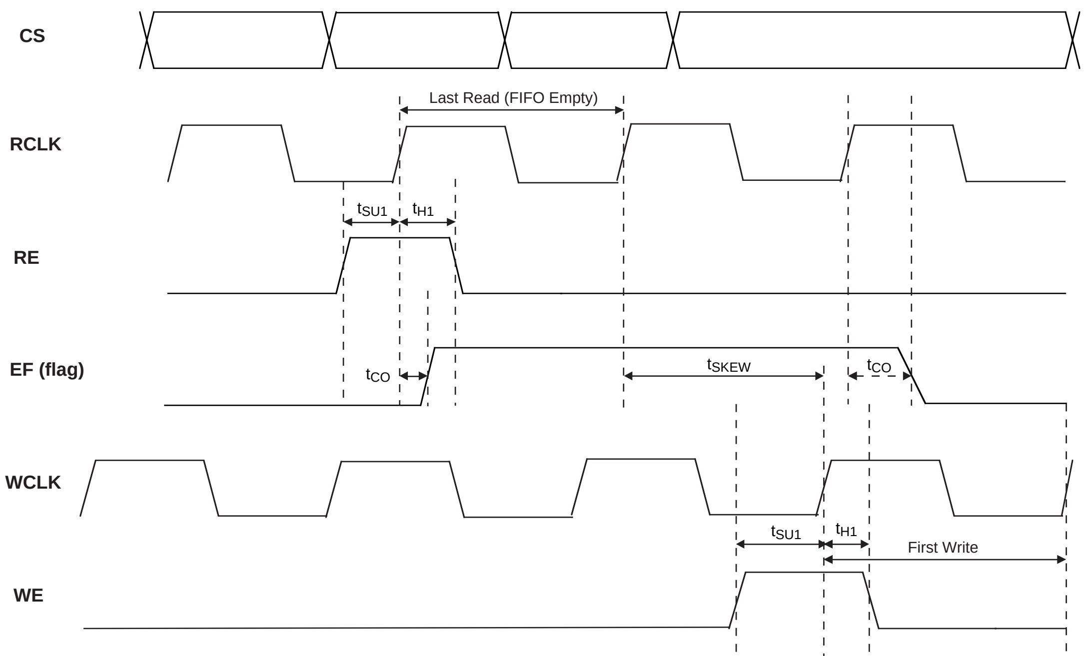


Figure 3-13. Waveform First Write after Empty Flag



sysCLOCK PLL Timing

Over Recommended Operating Conditions

Parameter	Description	Conditions	Min.	Typ	Max.	Units
f_{IN}	Input Clock Frequency (CLKI, CLKFB)		2	—	1000	MHz
f_{OUT}	Output Clock Frequency (CLKOP, CLKOS)		1.5625	—	1000	MHz
f_{VCO}	PLL VCO Frequency		100	—	1000	MHz
f_{PFD}	Phase Detector Input Frequency		2	—	700	MHz
AC Characteristics						
t_{DT}	Output Clock Duty Cycle	Default duty cycle selected (at 50% levels)	45	—	55	%
t_{OPJIT}[1]	Output Clock Period Jitter	2 MHz ≤ f_{PFD} ≤ 10 MHz	—	—	200	ps
		f_{PFD} > 10 MHz	—	—	100	ps
t_{CPJIT}[1]	Output Clock Cycle-to-Cycle Jitter		—	—	100	ps
t_{SKEW}	Output Clock-to-Clock Skew (Between Two Outputs with the Same Phase Setting)		—	—	20	ps
t_{LOCK}	PLL Lock-in Time		—	—	1	ms
t_{IPJIT}	Input Clock Period Jitter		—	—	±250	ps
t_{HI}	Input Clock High Time	At 80% level	350	—	—	ps
t_{LO}	Input Clock Low Time	At 20% level	350	—	—	ps
t_{RSWA}	Analog Reset Signal Pulse Width		100	—	—	ns
t_{RSWD}	Digital Reset Signal Pulse Width		3	—	—	ns
t_{DEL}	Timeshift Delay Step Size		40	80	120	ps
t_{RANGE}	Timeshift Delay Range		—	+/- 560	—	ps
f_{SS}	Spread Spectrum Modulation Frequency		30	—	500	KHz
% Spread	Percentage Downspread for SS Mode		0.5	—	1.5	%
	VCO Clock Phase Adjustment Accuracy		-5	—	5	°

1. Values are measured with FPGA logic active, no additional I/Os toggling and REFCLK total jitter = 30 ps

Switching Test Conditions

Figure 3-15 shows the output test load that is used for AC testing. The specific values for resistance, capacitance, voltage, and other test conditions are shown in Table 3-4.

Figure 3-15. Output Test Load, LVTTL and LVCMOS Standards

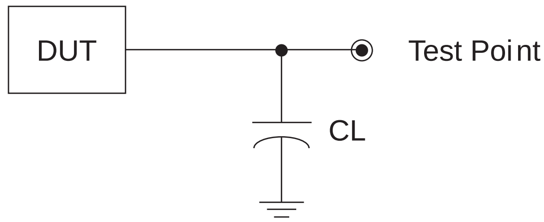


Table 3-4. Test Fixture Required Components, Non-Terminated Interfaces

Test Condition	C_L	Timing Ref.	V_T
LVTTL and other LVCMOS settings (L -> H, H -> L)	30pF	LVCMOS 3.3 = 1.5V	—
		LVCMOS 2.5 = $V_{CCIO}/2$	—
		LVCMOS 1.8 = $V_{CCIO}/2$	—
		LVCMOS 1.5 = $V_{CCIO}/2$	—
		LVCMOS 1.2 = $V_{CCIO}/2$	—
LVCMOS 2.5 I/O (Z -> H)	30pF	$V_{CCIO}/2$	V_{OL}
LVCMOS 2.5 I/O (Z -> L)		$V_{CCIO}/2$	V_{OH}
LVCMOS 2.5 I/O (H -> Z)		V_{OH} - 0.15	V_{OL}
LVCMOS 2.5 I/O (L -> Z)		V_{OL} + 0.15	V_{OH}

Note: Output test conditions for all other interfaces are determined by the respective standards.

Signal Descriptions (Cont.)

Signal Name	I/O	Description
RESP_[ULC/URC]	—	Calibration resistor to be placed between this pin and either ground or RESPN_[ULC/URC]. RESPN_[ULC/URC] is available on select packages. If available, connection of calibration resistor between RESP_[ULC/URC] and RESPN_[ULC/URC] takes precedence over connection of calibration resistor between RESP_[ULC/URC] and ground. Note: only one per side of the device. Value: 4.02K ohm +/- 1% ohm.
RESPN_[ULC/URC]	—	Available on selected packages. If available, calibration resistor should be placed between RESP_[ULC/URC] and RESPN_[ULC/URC] instead of between RESP_[ULC/URC] and ground. Note: only one per side of the device. Value: 4.02K ohm +/- 1% ohm.
[A:D]_VDDIBx_[L/R]	—	Input buffer power supply for channel x (1.2V/1.5V) on left [L] or right [R] side of device.
[A:D]_VDDOBx_[L/R]	—	Output buffer power supply for channel x (1.2V/1.5V) on left [L] or right [R] side of device.
[A:D]_VDDAX25_[L/R]	—	Auxiliary power for input and output termination (2.5V) on left [L] or right [R] side of device.

1. The ispLEVER software tools may specify VDDRX, VDDTX, VDDP and VCCL pins. These pins should be considered VCC12 pins.

Note: Signals listed as Signal A / Signal B define the same physical pin that is used for different functions based on configuration mode.

LFSC/M15 Logic Signal Connections: 256 fpBGA[1,2] (Cont.)

Ball Number	LFSC/M15		
	Ball Function	VCCIO Bank	Dual Function
M4	PL43B	6	
P1	PL45A	6	LLC_DLLT_IN_F/LLC_DLLT_FB_E
R1	PL45B	6	LLC_DLLC_IN_F/LLC_DLLC_FB_E
R2	XRES	-	
P3	TEMP	6	
R3	PB3A	5	LLC_PLLT_IN_A/LLC_PLLT_FB_B
N4	PB3B	5	LLC_PLLC_IN_A/LLC_PLLC_FB_B
T3	PB3C	5	LLC_DLLT_IN_C/LLC_DLLT_FB_D
T2	PB3D	5	LLC_DLLC_IN_C/LLC_DLLC_FB_D
N5	PB5D	5	VREF1_5
P5	PB8A	5	
R5	PB8B	5	
T4	PB9A	5	
T5	PB9B	5	
R6	PB12A	5	PCLKT5_3
T6	PB12B	5	PCLKC5_3
L5	PB13C	5	
P6	PB15A	5	PCLKT5_0
T7	PB15B	5	PCLKC5_0
M7	PB15D	5	VREF2_5
R8	PB16A	5	PCLKT5_1
T8	PB16B	5	PCLKC5_1
N7	PB17A	5	PCLKT5_2
N8	PB17B	5	PCLKC5_2
R9	PB20A	5	
T9	PB20B	5	
M8	PB21A	5	
M9	PB21B	5	
P8	PB24A	5	
P9	PB24B	5	
T10	PB28A	4	
R11	PB28B	4	
N9	PB31A	4	
N10	PB31B	4	
T11	PB32A	4	
R12	PB32B	4	
P11	PB35A	4	PCLKT4_2
M10	PB35B	4	PCLKC4_2
T12	PB36A	4	PCLKT4_1
P12	PB36B	4	PCLKC4_1
T13	PB37A	4	PCLKT4_0
T14	PB37B	4	PCLKC4_0
R15	PB37C	4	VREF2_4

LFSC/M15 Logic Signal Connections: 256 fpBGA[1,2] (Cont.)

Ball Number	LFSC/M15		
	Ball Function	VCCIO Bank	Dual Function
N12	PB39C	4	
T15	PB40A	4	PCLKT4_3
R16	PB40B	4	PCLKC4_3
L12	PB43A	4	
M12	PB43B	4	
P16	PB44A	4	
N16	PB44B	4	
R14	PB47C	4	VREF1_4
P15	PB48A	4	LRC_DLLT_IN_C/LRC_DLLT_FB_D
M13	PB48B	4	LRC_DLLC_IN_C/LRC_DLLC_FB_D
N13	PB49A	4	LRC_PLLT_IN_A/LRC_PLLT_FB_B
P14	PB49B	4	LRC_PLLC_IN_A/LRC_PLLC_FB_B
M16	PR45B	3	LRC_DLLC_IN_F/LRC_DLLC_FB_E
L16	PR45A	3	LRC_DLLT_IN_F/LRC_DLLT_FB_E
M14	PR43B	3	
M15	PR43A	3	
K16	PR41D	3	VREF2_3
J16	PR37B	3	
H16	PR37A	3	
L13	PR35D	3	DIFFR_3
L14	PR35B	3	
L15	PR35A	3	
K12	PR31C	3	VREF1_3
J13	PR28D	3	PCLKC3_2
K13	PR28C	3	PCLKT3_2
H15	PR28B	3	
F16	PR28A	3	
J11	PR26D	3	PCLKC3_1
J12	PR26C	3	PCLKT3_1
J15	PR26B	3	PCLKC3_0
J14	PR26A	3	PCLKT3_0
E16	PR24D	2	PCLKC2_2
D16	PR24C	2	PCLKT2_2
H11	PR24B	2	PCLKC2_0
H12	PR24A	2	PCLKT2_0
H13	PR23B	2	PCLKC2_1
H14	PR23A	2	PCLKT2_1
G12	PR22D	2	DIFFR_2
G13	PR22C	2	VREF1_2
F8	PR22B	2	
F9	PR22A	2	
G16	PR18D	2	VREF2_2
F15	PR17B	2	URC_DLLC_IN_C/URC_DLLC_FB_D

LFSC/M15, LFSC/M25 Logic Signal Connections: 900 fpBGA[1, 2] (Cont.)

	LFSC/M15			LFSC/M25		
Ball Number	Ball Function	VCCIO Bank	Dual Function	Ball Function	VCCIO Bank	Dual Function
AH20	NC	-		PB51D	4	
AK27	NC	-		NC	-	
AJ24	NC	-		NC	-	
AF17	NC	-		PB42C	4	
AH27	NC	-		PB61B	4	
AD23	NC	-		PB57A	4	
AE23	NC	-		PB57B	4	
AH24	NC	-		PB59A	4	
AH25	NC	-		PB59B	4	
AH26	NC	-		PB61A	4	
AF24	NC	-		PB63A	4	
AG24	NC	-		PB63B	4	
AG25	NC	-		PB64A	4	
AF25	NC	-		PB64B	4	
AG26	NC	-		PB65A	4	
AF27	NC	-		PB65B	4	
AD28	NC	-		PR56B	3	
AC27	NC	-		PR56A	3	
AE29	NC	-		PR53B	3	
AD29	NC	-		PR53A	3	
AB30	NC	-		NC	-	
AA28	NC	-		NC	-	
Y27	NC	-		PR47C	3	
W27	NC	-		PR47D	3	
V30	NC	-		PR47A	3	
W30	NC	-		PR47B	3	
W26	NC	-		PR43D	3	
V26	NC	-		PR43C	3	
U25	NC	-		PR42C	3	
T27	NC	-		PR40B	3	
R27	NC	-		PR40A	3	
V27	NC	-		PR39B	3	
U27	NC	-		PR39A	3	
U29	NC	-		PR36B	3	
T29	NC	-		PR36A	3	
T24	NC	-		PR35C	3	
Y25	NC	-		PR48C	3	
P24	NC	-		NC	-	
K28	NC	-		NC	-	
P23	NC	-		NC	-	
L28	NC	-		NC	-	
M27	NC	-		PR21B	2	
L27	NC	-		PR21A	2	
H27	NC	-		PR20B	2	
G27	NC	-		PR20A	2	

LFSC/M15, LFSC/M25 Logic Signal Connections: 900 fpBGA[1, 2] (Cont.)

Ball Number	LFSC/M15			LFSC/M25		
	Ball Function	VCCIO Bank	Dual Function	Ball Function	VCCIO Bank	Dual Function
AJ27	GND	-		GND	-	
AF23	GND	-		GND	-	
AF22	GND	-		GND	-	
AE27	GND	-		GND	-	
AA27	GND	-		GND	-	
AB29	GND	-		GND	-	
Y26	GND	-		GND	-	
AC30	GND	-		GND	-	
Y29	GND	-		GND	-	
F30	GND	-		GND	-	
E27	GND	-		GND	-	
F27	GND	-		GND	-	
P25	GND	-		GND	-	
H29	GND	-		GND	-	
K29	GND	-		GND	-	
R24	GND	-		GND	-	
M28	GND	-		GND	-	
J27	GND	-		GND	-	
N26	GND	-		GND	-	
E20	GND	-		GND	-	
E21	GND	-		GND	-	
F21	GND	-		GND	-	
F23	GND	-		GND	-	
G23	GND	-		GND	-	
D21	GND	-		GND	-	
D20	GND	-		GND	-	
E18	GND	-		GND	-	
C20	GND	-		GND	-	
C11	GND	-		GND	-	
A12	GND	-		GND	-	
E11	GND	-		GND	-	
F8	GND	-		GND	-	
G8	GND	-		GND	-	
D11	GND	-		GND	-	
D10	GND	-		GND	-	
H7	GND	-		GND	-	
F10	GND	-		GND	-	
E10	GND	-		GND	-	
AC16	NC	-		NC	-	
J22	VCC	-		VCC	-	
J9	VCC	-		VCC	-	
B2	NC	-		NC	-	
C2	RESPN_ULC	-		RESPN_ULC	-	
C29	RESPN_URC	-		RESPN_URC	-	

LFSC/M25, LFSC/M40 Logic Signal Connections: 1020 fcBGA[1, 2] (Cont.)

Ball Number	LFSC/M25			LFSC/M40		
	Ball Function	VCCIO Bank	Dual Function	Ball Function	VCCIO Bank	Dual Function
H1	PR25B	2		PR23B	2	
H2	PR25A	2		PR23A	2	
N8	PR22D	2		PR25D	2	
M8	PR22C	2		PR25C	2	
H4	PR22B	2		PR25B	2	
J4	PR22A	2		PR25A	2	
G1	PR21B	2		PR22B	2	
G2	PR21A	2		PR22A	2	
L7	PR20D	2		PR21D	2	
L8	PR20C	2		PR21C	2	
F2	PR20B	2		PR21B	2	
F1	PR20A	2		PR21A	2	
K5	PR18D	2	VREF2_2	PR18D	2	VREF2_2
J5	PR18C	2		PR18C	2	
E2	PR18B	2	URC_DLLC_IN_D/URC_DLLC_FB_C	PR18B	2	URC_DLLC_IN_D/URC_DLLC_FB_C
E1	PR18A	2	URC_DLLT_IN_D/URC_DLLT_FB_C	PR18A	2	URC_DLLT_IN_D/URC_DLLT_FB_C
N10	PR17D	2	URC_PLLC_IN_B/URC_PLLC_FB_A	PR17D	2	URC_PLLC_IN_B/URC_PLLC_FB_A
M10	PR17C	2	URC_PLLT_IN_B/URC_PLLT_FB_A	PR17C	2	URC_PLLT_IN_B/URC_PLLT_FB_A
D2	PR17B	2	URC_DLLC_IN_C/URC_DLLC_FB_D	PR17B	2	URC_DLLC_IN_C/URC_DLLC_FB_D
D1	PR17A	2	URC_DLLT_IN_C/URC_DLLT_FB_D	PR17A	2	URC_DLLT_IN_C/URC_DLLT_FB_D
K6	PR16D	2		PR16D	2	
K7	PR16C	2		PR16C	2	
J8	PR16B	2	URC_PLLC_IN_A/URC_PLLC_FB_B	PR16B	2	URC_PLLC_IN_A/URC_PLLC_FB_B
K8	PR16A	2	URC_PLLT_IN_A/URC_PLLT_FB_B	PR16A	2	URC_PLLT_IN_A/URC_PLLT_FB_B
J10	VCCJ	-		VCCJ	-	
J9	TDO	-	TDO	TDO	-	TDO
K9	TMS	-		TMS	-	
J12	TCK	-		TCK	-	
J13	TDI	-		TDI	-	
K12	PROGRAMN	1		PROGRAMN	1	
K13	MPIIRQN	1	CFGIRQN/MPI_IRQ_N	MPIIRQN	1	CFGIRQN/MPI_IRQ_N
K10	CCLK	1		CCLK	1	
F5	RESP_URC	-		RESP_URC	-	
B5	VCC12	-		VCC12	-	
D5	A_REFCLKN_R	-		A_REFCLKN_R	-	
C5	A_REFCLKP_R	-		A_REFCLKP_R	-	
B2	A_VDDIB0_R	-		A_VDDIB0_R	-	
C1	A_HDINP0_R	-	PCS 3E0 CH 0 IN P	A_HDINP0_R	-	PCS 3E0 CH 0 IN P
C2	A_HDINN0_R	-	PCS 3E0 CH 0 IN N	A_HDINN0_R	-	PCS 3E0 CH 0 IN N
A3	A_HDOUTP0_R	-	PCS 3E0 CH 0 OUT P	A_HDOUTP0_R	-	PCS 3E0 CH 0 OUT P
D3	A_VDDOB0_R	-		A_VDDOB0_R	-	
B3	A_HDOUTN0_R	-	PCS 3E0 CH 0 OUT N	A_HDOUTN0_R	-	PCS 3E0 CH 0 OUT N
D4	A_VDDOB1_R	-		A_VDDOB1_R	-	
B4	A_HDOUTN1_R	-	PCS 3E0 CH 1 OUT N	A_HDOUTN1_R	-	PCS 3E0 CH 1 OUT N
A4	A_HDOUTP1_R	-	PCS 3E0 CH 1 OUT P	A_HDOUTP1_R	-	PCS 3E0 CH 1 OUT P
H5	A_HDINN1_R	-	PCS 3E0 CH 1 IN N	A_HDINN1_R	-	PCS 3E0 CH 1 IN N
G5	A_HDINP1_R	-	PCS 3E0 CH 1 IN P	A_HDINP1_R	-	PCS 3E0 CH 1 IN P
F4	A_VDDIB1_R	-		A_VDDIB1_R	-	
H6	A_VDDIB2_R	-		A_VDDIB2_R	-	
F6	A_HDINP2_R	-	PCS 3E0 CH 2 IN P	A_HDINP2_R	-	PCS 3E0 CH 2 IN P

LFSC/M40, LFSC/M80 Logic Signal Connections: 1152 fcBGA[1, 2] (Cont.)

	LFSC/M40			LFSC/M80		
Ball Number	Ball Function	VCCIO Bank	Dual Function	Ball Function	VCCIO Bank	Dual Function
D7	B_VDDIB0_R	-		B_VDDIB0_R	-	
E10	B_HDINP0_R	-	PCS 3E1 CH 0 IN P	B_HDINP0_R	-	PCS 3E1 CH 0 IN P
F10	B_HDINN0_R	-	PCS 3E1 CH 0 IN N	B_HDINN0_R	-	PCS 3E1 CH 0 IN N
K10	VCC12	-		VCC12	-	
A11	B_HDOUTP0_R	-	PCS 3E1 CH 0 OUT P	B_HDOUTP0_R	-	PCS 3E1 CH 0 OUT P
D10	B_VDDOB0_R	-		B_VDDOB0_R	-	
B11	B_HDOUTN0_R	-	PCS 3E1 CH 0 OUT N	B_HDOUTN0_R	-	PCS 3E1 CH 0 OUT N
D11	B_VDDOB1_R	-		B_VDDOB1_R	-	
B12	B_HDOUTN1_R	-	PCS 3E1 CH 1 OUT N	B_HDOUTN1_R	-	PCS 3E1 CH 1 OUT N
L10	VCC12	-		VCC12	-	
A12	B_HDOUTP1_R	-	PCS 3E1 CH 1 OUT P	B_HDOUTP1_R	-	PCS 3E1 CH 1 OUT P
F11	B_HDINN1_R	-	PCS 3E1 CH 1 IN N	B_HDINN1_R	-	PCS 3E1 CH 1 IN N
E11	B_HDINP1_R	-	PCS 3E1 CH 1 IN P	B_HDINP1_R	-	PCS 3E1 CH 1 IN P
G11	VCC12	-		VCC12	-	
D8	B_VDDIB1_R	-		B_VDDIB1_R	-	
G12	VCC12	-		VCC12	-	
D9	B_VDDIB2_R	-		B_VDDIB2_R	-	
E12	B_HDINP2_R	-	PCS 3E1 CH 2 IN P	B_HDINP2_R	-	PCS 3E1 CH 2 IN P
F12	B_HDINN2_R	-	PCS 3E1 CH 2 IN N	B_HDINN2_R	-	PCS 3E1 CH 2 IN N
K11	VCC12	-		VCC12	-	
A13	B_HDOUTP2_R	-	PCS 3E1 CH 2 OUT P	B_HDOUTP2_R	-	PCS 3E1 CH 2 OUT P
D12	B_VDDOB2_R	-		B_VDDOB2_R	-	
B13	B_HDOUTN2_R	-	PCS 3E1 CH 2 OUT N	B_HDOUTN2_R	-	PCS 3E1 CH 2 OUT N
D13	B_VDDOB3_R	-		B_VDDOB3_R	-	
B14	B_HDOUTN3_R	-	PCS 3E1 CH 3 OUT N	B_HDOUTN3_R	-	PCS 3E1 CH 3 OUT N
L11	VCC12	-		VCC12	-	
A14	B_HDOUTP3_R	-	PCS 3E1 CH 3 OUT P	B_HDOUTP3_R	-	PCS 3E1 CH 3 OUT P
F13	B_HDINN3_R	-	PCS 3E1 CH 3 IN N	B_HDINN3_R	-	PCS 3E1 CH 3 IN N
E13	B_HDINP3_R	-	PCS 3E1 CH 3 IN P	B_HDINP3_R	-	PCS 3E1 CH 3 IN P
G13	VCC12	-		VCC12	-	
E9	B_VDDIB3_R	-		B_VDDIB3_R	-	
L13	VCC12	-		VCC12	-	
J11	B_REFCLKN_R	-		B_REFCLKN_R	-	
H11	B_REFCLKP_R	-		B_REFCLKP_R	-	
M15	PT61D	1	HDC/SI	PT77D	1	HDC/SI
M16	PT61C	1	LDCN/SCS	PT77C	1	LDCN/SCS
F14	PT59B	1	D8/MPI_DATA8	PT77B	1	D8/MPI_DATA8
G14	PT59A	1	CS1/MPI_CS1	PT77A	1	CS1/MPI_CS1
L15	PT58D	1	D9/MPI_DATA9	PT75D	1	D9/MPI_DATA9
L14	PT58C	1	D10/MPI_DATA10	PT75C	1	D10/MPI_DATA10
D14	PT57B	1	CS0N/MPI_CS0N	PT75B	1	CS0N/MPI_CS0N
E14	PT57A	1	RDN/MPI_STRB_N	PT75A	1	RDN/MPI_STRB_N
L16	PT55D	1	WRN/MPI_WR_N	PT74D	1	WRN/MPI_WR_N
K16	PT55C	1	D7/MPI_DATA7	PT74C	1	D7/MPI_DATA7
G15	PT55B	1	D6/MPI_DATA6	PT74B	1	D6/MPI_DATA6

LFSC/M115 Logic Signal Connections: 1152 fcBGA[1, 2]

	LFSC/M115		
Ball Number	Ball Function	VCCIO Bank	Dual Function
AN15	PB89A	4	PCLKT4_2
AN14	PB89B	4	PCLKC4_2
AE16	PB89C	4	PCLKT4_7
AD16	PB89D	4	PCLKC4_7
AK15	PB90A	4	PCLKT4_1
AK14	PB90B	4	PCLKC4_1
AG15	PB90C	4	PCLKT4_6
AG14	PB90D	4	PCLKC4_6
AM13	PB91A	4	PCLKT4_0
AM12	PB91B	4	PCLKC4_0
AJ12	PB91C	4	VREF2_4
AJ11	PB91D	4	
AL13	PB93A	4	PCLKT4_5
AL12	PB93B	4	PCLKC4_5
AH12	PB93C	4	
AH11	PB93D	4	
AN13	PB94A	4	PCLKT4_3
AN12	PB94B	4	PCLKC4_3
AD14	PB94C	4	PCLKT4_4
AD15	PB94D	4	PCLKC4_4
AP13	PB87A	4	
AP12	PB87B	4	
AK13	PB87C	4	
AK12	PB87D	4	
AP11	PB97A	4	
AP10	PB97B	4	
AN11	PB113A	4	
AN10	PB113B	4	
AF14	PB113C	4	
AF13	PB113D	4	
AM10	PB115A	4	
AM9	PB115B	4	
AE14	PB115C	4	
AE13	PB115D	4	
AP9	PB118A	4	
AP8	PB118B	4	
AK11	PB118C	4	
AK10	PB118D	4	
AL10	PB121A	4	
AL9	PB121B	4	
AF12	PB121C	4	
AF11	PB121D	4	
AN9	PB123A	4	

LFSC/M80, LFSC/M115 Logic Signal Connections: 1704 fcBGA[1, 2] (Cont.)

Ball Number	LFSC/M80			LFSC/M115		
	Ball Function	VCCIO Bank	Dual Function	Ball Function	VCCIO Bank	Dual Function
AB25	VCC	-		VCC	-	
AB26	VCC	-		VCC	-	
AC16	VCC	-		VCC	-	
AC18	VCC	-		VCC	-	
AC20	VCC	-		VCC	-	
AC23	VCC	-		VCC	-	
AC25	VCC	-		VCC	-	
AC27	VCC	-		VCC	-	
AD17	VCC	-		VCC	-	
AD19	VCC	-		VCC	-	
AD21	VCC	-		VCC	-	
AD22	VCC	-		VCC	-	
AD24	VCC	-		VCC	-	
AD26	VCC	-		VCC	-	
AE16	VCC	-		VCC	-	
AE18	VCC	-		VCC	-	
AE20	VCC	-		VCC	-	
AE21	VCC	-		VCC	-	
AE22	VCC	-		VCC	-	
AE23	VCC	-		VCC	-	
AE25	VCC	-		VCC	-	
AE27	VCC	-		VCC	-	
AF17	VCC	-		VCC	-	
AF19	VCC	-		VCC	-	
AF21	VCC	-		VCC	-	
AF22	VCC	-		VCC	-	
AF24	VCC	-		VCC	-	
AF26	VCC	-		VCC	-	
AG18	VCC	-		VCC	-	
AG20	VCC	-		VCC	-	
AG23	VCC	-		VCC	-	
AG25	VCC	-		VCC	-	
T18	VCC	-		VCC	-	
T20	VCC	-		VCC	-	
T23	VCC	-		VCC	-	
T25	VCC	-		VCC	-	
U17	VCC	-		VCC	-	
U19	VCC	-		VCC	-	
U21	VCC	-		VCC	-	
U22	VCC	-		VCC	-	
U24	VCC	-		VCC	-	
U26	VCC	-		VCC	-	
V16	VCC	-		VCC	-	
V18	VCC	-		VCC	-	
V20	VCC	-		VCC	-	

LFSC/M80, LFSC/M115 Logic Signal Connections: 1704 fcBGA[1, 2] (Cont.)

Ball Number	LFSC/M80			LFSC/M115		
	Ball Function	VCCIO Bank	Dual Function	Ball Function	VCCIO Bank	Dual Function
AH27	VCCAUX	-		VCCAUX	-	
AH29	VCCAUX	-		VCCAUX	-	
AJ14	VCCAUX	-		VCCAUX	-	
AJ15	VCCAUX	-		VCCAUX	-	
AJ28	VCCAUX	-		VCCAUX	-	
AJ29	VCCAUX	-		VCCAUX	-	
P14	VCCAUX	-		VCCAUX	-	
P15	VCCAUX	-		VCCAUX	-	
P28	VCCAUX	-		VCCAUX	-	
P29	VCCAUX	-		VCCAUX	-	
R14	VCCAUX	-		VCCAUX	-	
R16	VCCAUX	-		VCCAUX	-	
R17	VCCAUX	-		VCCAUX	-	
R18	VCCAUX	-		VCCAUX	-	
R19	VCCAUX	-		VCCAUX	-	
R20	VCCAUX	-		VCCAUX	-	
R23	VCCAUX	-		VCCAUX	-	
R24	VCCAUX	-		VCCAUX	-	
R25	VCCAUX	-		VCCAUX	-	
R26	VCCAUX	-		VCCAUX	-	
R27	VCCAUX	-		VCCAUX	-	
R29	VCCAUX	-		VCCAUX	-	
T15	VCCAUX	-		VCCAUX	-	
T28	VCCAUX	-		VCCAUX	-	
U15	VCCAUX	-		VCCAUX	-	
U28	VCCAUX	-		VCCAUX	-	
V15	VCCAUX	-		VCCAUX	-	
V28	VCCAUX	-		VCCAUX	-	
W15	VCCAUX	-		VCCAUX	-	
W28	VCCAUX	-		VCCAUX	-	
Y15	VCCAUX	-		VCCAUX	-	
Y28	VCCAUX	-		VCCAUX	-	
F3	VCCIO1	-		VCCIO1	-	
F39	VCCIO1	-		VCCIO1	-	
G35	VCCIO1	-		VCCIO1	-	
G8	VCCIO1	-		VCCIO1	-	
L19	VCCIO1	-		VCCIO1	-	
L24	VCCIO1	-		VCCIO1	-	
M16	VCCIO1	-		VCCIO1	-	
M27	VCCIO1	-		VCCIO1	-	
N11	VCCIO1	-		VCCIO1	-	
N32	VCCIO1	-		VCCIO1	-	
AA4	VCCIO2	-		VCCIO2	-	
H7	VCCIO2	-		VCCIO2	-	
J4	VCCIO2	-		VCCIO2	-	

LFSC/M80, LFSC/M115 Logic Signal Connections: 1704 fcBGA[1, 2] (Cont.)

	LFSC/M80			LFSC/M115		
Ball Number	Ball Function	VCCIO Bank	Dual Function	Ball Function	VCCIO Bank	Dual Function
AH22	VTT_5	5		VTT_5	5	
AJ22	VTT_5	5		VTT_5	5	
AJ23	VTT_5	5		VTT_5	5	
AJ24	VTT_5	5		VTT_5	5	
AJ25	VTT_5	5		VTT_5	5	
AB28	VTT_6	6		VTT_6	6	
AB29	VTT_6	6		VTT_6	6	
AE29	VTT_6	6		VTT_6	6	
AJ30	VTT_6	6		VTT_6	6	
AA28	VTT_7	7		VTT_7	7	
AA29	VTT_7	7		VTT_7	7	
R31	VTT_7	7		VTT_7	7	
V29	VTT_7	7		VTT_7	7	
Y24	GND	-		GND	-	
Y26	GND	-		GND	-	
Y8	GND	-		GND	-	
Y35	GND	-		GND	-	
AA16	VCC12	-		VCC12	-	
AA27	VCC12	-		VCC12	-	
AB16	VCC12	-		VCC12	-	
AB27	VCC12	-		VCC12	-	
AF16	VCC12	-		VCC12	-	
AF27	VCC12	-		VCC12	-	
AG17	VCC12	-		VCC12	-	
AG21	VCC12	-		VCC12	-	
G33	NC	-		NC	-	
G10	NC	-		NC	-	
M15	NC	-		NC	-	
L15	NC	-		NC	-	
K16	NC	-		NC	-	
J16	NC	-		NC	-	
M18	NC	-		NC	-	
L18	NC	-		NC	-	
M25	NC	-		NC	-	
L25	NC	-		NC	-	
J27	NC	-		NC	-	
K27	NC	-		NC	-	
L28	NC	-		NC	-	
M28	NC	-		NC	-	

1. Differential pair grouping within a PIC is A (True) and B (Complement) and C (True) and D (Complement).
2. The LatticeSC/M80 and LatticeSC/M115 in a 1704-pin package supports a 32-bit MPI interface.

Industrial, Cont.

Part Number	Grade	Package	Balls	Temp.	LUTs (K)
LFSCM3GA40EP1-6FF1020I[1]	-6	Organic fcBGA	1020	IND	40.4
LFSCM3GA40EP1-5FF1020I[1]	-5	Organic fcBGA	1020	IND	40.4
LFSCM3GA40EP1-6FFA1020I	-6	Organic fcBGA Revision 2	1020	IND	40.4
LFSCM3GA40EP1-5FFA1020I	-5	Organic fcBGA Revision 2	1020	IND	40.4
LFSCM3GA40EP1-6FC1152I[2]	-6	Ceramic fcBGA	1152	IND	40.4
LFSCM3GA40EP1-5FC1152I[2]	-5	Ceramic fcBGA	1152	IND	40.4
LFSCM3GA40EP1-6FF1152I	-6	Organic fcBGA	1152	IND	40.4
LFSCM3GA40EP1-5FF1152I	-5	Organic fcBGA	1152	IND	40.4

1. Converted to organic flip-chip BGA package revision 2 per PCN #02A-10.
2. Converted to organic flip-chip BGA package per PCN #01A-10.

Part Number	Grade	Package	Balls	Temp.	LUTs (K)
LFSC3GA80E-6FC1152I[1]	-6	Ceramic fcBGA	1152	IND	80.1
LFSC3GA80E-5FC1152I[1]	-5	Ceramic fcBGA	1152	IND	80.1
LFSC3GA80E-6FF1152I	-6	Organic fcBGA	1152	IND	80.1
LFSC3GA80E-5FF1152I	-5	Organic fcBGA	1152	IND	80.1
LFSC3GA80E-6FC1704I[1]	-6	Ceramic fcBGA	1704	IND	80.1
LFSC3GA80E-5FC1704I[1]	-5	Ceramic fcBGA	1704	IND	80.1
LFSC3GA80E-6FF1704I	-6	Organic fcBGA	1704	IND	80.1
LFSC3GA80E-5FF1704I	-5	Organic fcBGA	1704	IND	80.1

1. Converted to organic flip-chip BGA package per PCN #01A-10.

Part Number	Grade	Package	Balls	Temp.	LUTs (K)
LFSCM3GA80EP1-6FC1152I[1]	-6	Ceramic fcBGA	1152	IND	80.1
LFSCM3GA80EP1-5FC1152I[1]	-5	Ceramic fcBGA	1152	IND	80.1
LFSCM3GA80EP1-6FF1152I	-6	Organic fcBGA	1152	IND	80.1
LFSCM3GA80EP1-5FF1152I	-5	Organic fcBGA	1152	IND	80.1
LFSCM3GA80EP1-6FC1704I[1]	-6	Ceramic fcBGA	1704	IND	80.1
LFSCM3GA80EP1-5FC1704I[1]	-5	Ceramic fcBGA	1704	IND	80.1
LFSCM3GA80EP1-6FF1704I	-6	Organic fcBGA	1704	IND	80.1
LFSCM3GA80EP1-5FF1704I	-5	Organic fcBGA	1704	IND	80.1

1. Converted to organic flip-chip BGA package per PCN #01A-10.